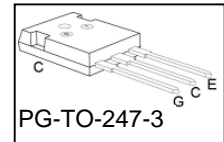
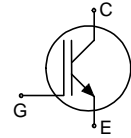


## Low Loss IGBT in TrenchStop® and Fieldstop technology

- Short circuit withstand time – 10µs
- Designed for :
  - Frequency Converters
  - Uninterrupted Power Supply
- TrenchStop® and Fieldstop technology for 1200 V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
- NPT technology offers easy parallel switching capability due to positive temperature coefficient in  $V_{CE(sat)}$
- Low EMI
- Low Gate Charge
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>



| Type      | $V_{CE}$ | $I_C$ | $V_{CE(sat), T_j=25^\circ C}$ | $T_{j,max}$ | Marking Code | Package     |
|-----------|----------|-------|-------------------------------|-------------|--------------|-------------|
| IGW40T120 | 1200V    | 40A   | 1.7V                          | 150°C       | G40T120      | PG-TO-247-3 |

**Maximum Ratings**

| Parameter  | Symbol       | Value      | Unit |
|--|--------------|------------|------|
| Collector-emitter voltage                                  | $V_{CE}$     | 1200       | V    |
| DC collector current                                       | $I_C$        |            | A    |
| $T_C = 25^\circ C$   |              | 75         |      |
| $T_C = 100^\circ C$  |              | 40         |      |
| Pulsed collector current, $t_p$ limited by $T_{j,max}$     | $I_{C,puls}$ | 105        |      |
| Turn off safe operating area                               | -            | 105        |      |
| $V_{CE} \leq 1200V, T_j \leq 150^\circ C$                  |              |            |      |
| Gate-emitter voltage                                       | $V_{GE}$     | $\pm 20$   | V    |
| Short circuit withstand time <sup>2)</sup>                 | $t_{SC}$     | 10         | µs   |
| $V_{GE} = 15V, V_{CC} \leq 1200V, T_j \leq 150^\circ C$    |              |            |      |
| Power dissipation  | $P_{tot}$    | 270        | W    |
| $T_C = 25^\circ C$   |              |            |      |
| Operating junction temperature                             | $T_j$        | -40...+150 | °C   |
| Storage temperature  | $T_{stg}$    | -55...+150 |      |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s | -            | 260        |      |

<sup>1</sup> J-STD-020 and JESD-022

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

**Thermal Resistance**

| Parameter                                   | Symbol     | Conditions | Max. Value | Unit |
|---|------------|------------|------------|------|
| <b>Characteristic</b>                       |            |            |            |      |
| IGBT thermal resistance,<br>junction – case | $R_{thJC}$ |            | 0.45       | K/W  |
| Thermal resistance,<br>junction – ambient   | $R_{thJA}$ |            | 40         |      |

**Electrical Characteristic, at  $T_j = 25\text{ °C}$ , unless otherwise specified**

| Parameter                            | Symbol        | Conditions   | Value               |                     |      | Unit     |     |
|--------------------------------------|---------------|--|---------------------|---------------------|------|----------|-----|
|                                      |               |  | min.                | typ.                | max. |          |     |
| <b>Static Characteristic</b>         |               |  |                     |                     |      |          |     |
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$ | $V_{GE}=0V, I_C=1.5mA$                               | 1200                | -                   | -    | V        |     |
| Collector-emitter saturation voltage | $V_{CE(sat)}$ | $V_{GE} = 15V, I_C=40A$<br>$T_j=25\text{ °C}$        | -                   | 1.7                 | 2.3  |          |     |
|                                      |               |  | $T_j=125\text{ °C}$ | -                   | 2.1  |          | -   |
|                                      |               |  |                     | $T_j=150\text{ °C}$ | -    |          | 2.3 |
| Gate-emitter threshold voltage       | $V_{GE(th)}$  | $I_C=1.5mA, V_{CE}=V_{GE}$                           | 5.0                 | 5.8                 | 6.5  |          |     |
| Zero gate voltage collector current  | $I_{CES}$     | $V_{CE}=1200V,$<br>$V_{GE}=0V$<br>$T_j=25\text{ °C}$ | -                   | -                   | 0.4  | mA       |     |
|                                      |               |  | $T_j=150\text{ °C}$ | -                   | -    |          | 4.0 |
| Gate-emitter leakage current         | $I_{GES}$     | $V_{CE}=0V, V_{GE}=20V$                              | -                   | -                   | 600  | nA       |     |
| Transconductance                     | $g_{fs}$      | $V_{CE}=20V, I_C=40A$                                | -                   | 21                  | -    | S        |     |
| Integrated gate resistor             | $R_{Gint}$    |  |                     | 6                   |      | $\Omega$ |     |

**Dynamic Characteristic**

|   |             |   |   |      |   |    |
|---|-------------|---|---|------|---|----|
| Input capacitance   | $C_{iss}$   | $V_{CE}=25V,$<br>$V_{GE}=0V,$<br>$f=1MHz$                                   | - | 2500 | - | pF |
| Output capacitance  | $C_{oss}$   |   | - | 130  | - |    |
| Reverse transfer capacitance                                      | $C_{rss}$   |   | - | 110  | - |    |
| Gate charge   | $Q_{Gate}$  | $V_{CC}=960V, I_C=40A$<br>$V_{GE}=15V$                                      | - | 203  | - | nC |
| Internal emitter inductance<br>measured 5mm (0.197 in.) from case | $L_E$       |   | - | 13   | - | nH |
| Short circuit collector current <sup>1)</sup>                     | $I_{C(SC)}$ | $V_{GE}=15V, t_{SC} \leq 10\mu s$<br>$V_{CC} = 600V,$<br>$T_j = 25^\circ C$ | - | 210  | - | A  |

**Switching Characteristic, Inductive Load, at  $T_j=25^\circ C$** 

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

**IGBT Characteristic**

|                        |              |  |   |     |   |    |
|------------------------|--------------|--|---|-----|---|----|
| Turn-on delay time     | $t_{d(on)}$  | $T_j=25^\circ C,$<br>$V_{CC}=600V, I_C=40A,$<br>$V_{GE}=0/15V,$<br>$R_G=15\Omega,$<br>$L_\sigma^{2)}=180nH,$<br>$C_\sigma^{2)}=39pF$<br>Energy losses include<br>"tail" and diode<br>reverse recovery. | - | 48  | - | ns |
| Rise time              | $t_r$        |  | - | 34  | - |    |
| Turn-off delay time    | $t_{d(off)}$ |  | - | 480 | - |    |
| Fall time              | $t_f$        |  | - | 70  | - |    |
| Turn-on energy         | $E_{on}$     |  | - | 3.3 | - | mJ |
| Turn-off energy        | $E_{off}$    |  | - | 3.2 | - |    |
| Total switching energy | $E_{ts}$     |  | - | 6.5 | - |    |

**Switching Characteristic, Inductive Load, at  $T_j=150^\circ C$** 

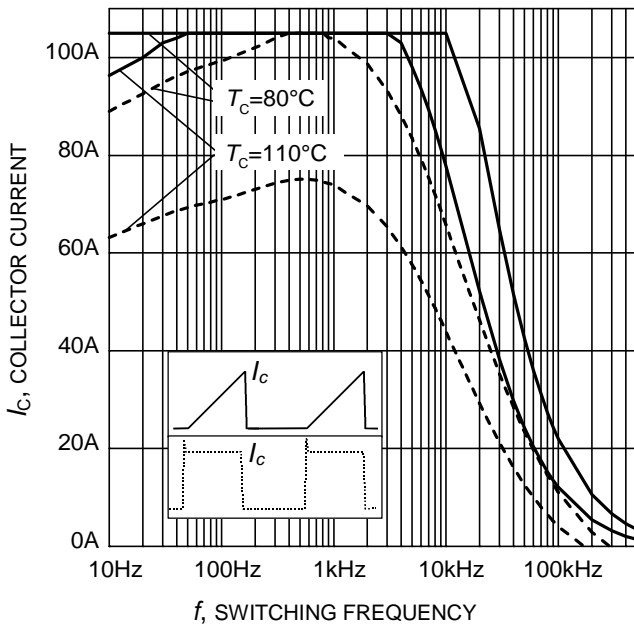
| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | typ. | max. |      |

**IGBT Characteristic**

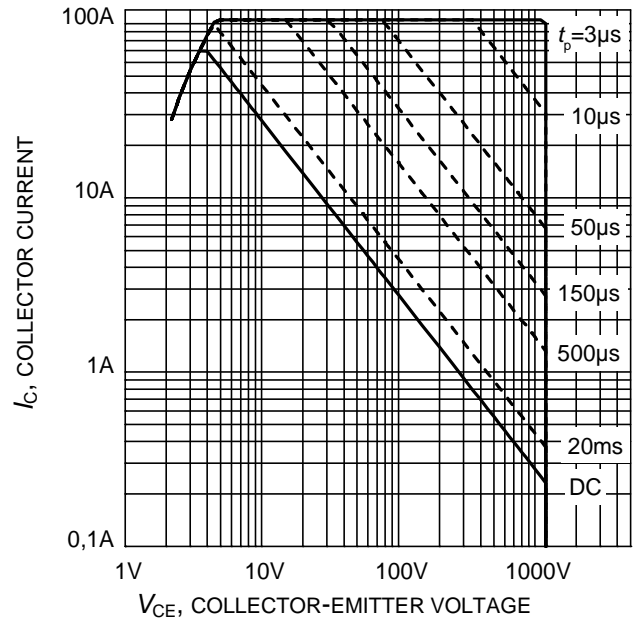
|                        |              |  |   |      |   |    |
|------------------------|--------------|--|---|------|---|----|
| Turn-on delay time     | $t_{d(on)}$  | $T_j=150^\circ C$<br>$V_{CC}=600V, I_C=40A,$<br>$V_{GE}=0/15V,$<br>$R_G=15\Omega,$<br>$L_\sigma^{2)}=180nH,$<br>$C_\sigma^{2)}=39pF$<br>Energy losses include<br>"tail" and diode<br>reverse recovery. | - | 52   | - | ns |
| Rise time              | $t_r$        |  | - | 40   | - |    |
| Turn-off delay time    | $t_{d(off)}$ |  | - | 580  | - |    |
| Fall time              | $t_f$        |  | - | 120  | - |    |
| Turn-on energy         | $E_{on}$     |  | - | 5.0  | - | mJ |
| Turn-off energy        | $E_{off}$    |  | - | 5.4  | - |    |
| Total switching energy | $E_{ts}$     |  | - | 10.4 | - |    |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

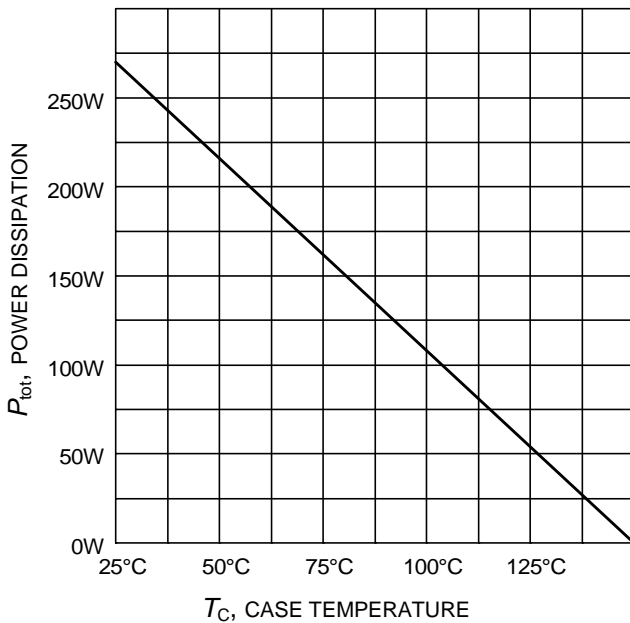
<sup>2)</sup> Leakage inductance  $L_\sigma$  and Stray capacity  $C_\sigma$  due to dynamic test circuit in Figure E.



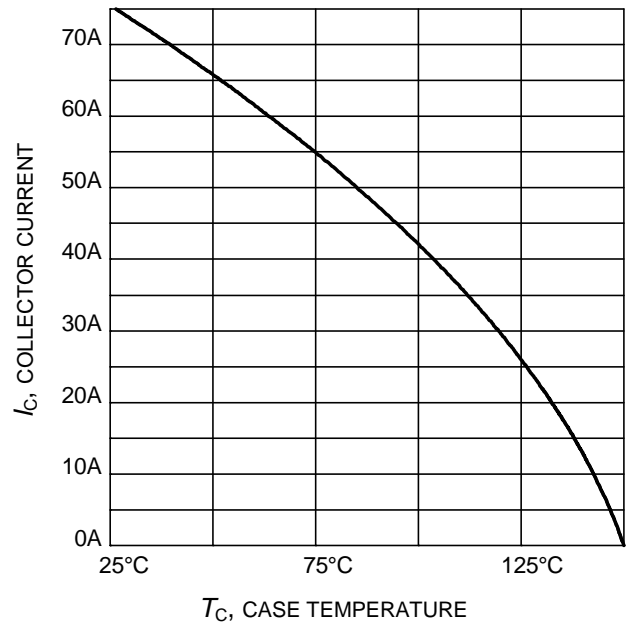
**Figure 1. Collector current as a function of switching frequency**  
 ( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 600\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 15\Omega$ )



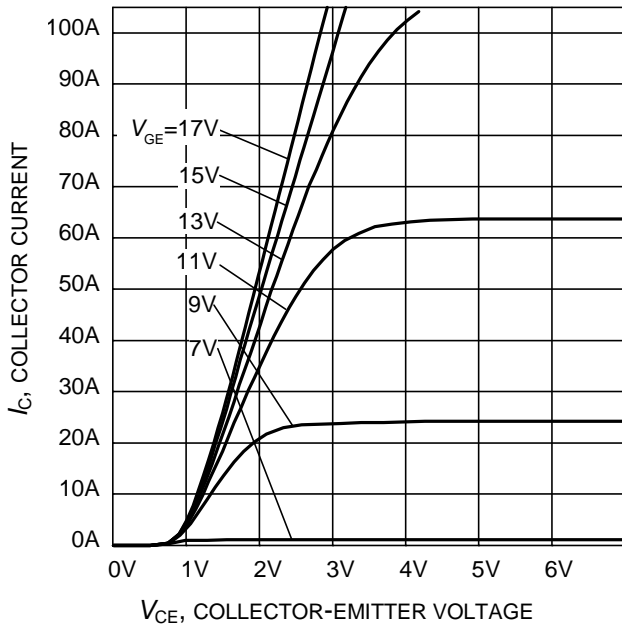
**Figure 2. Safe operating area**  
 ( $D = 0$ ,  $T_C = 25^\circ\text{C}$ ,  
 $T_j \leq 150^\circ\text{C}$ ;  $V_{GE} = 15\text{V}$ )



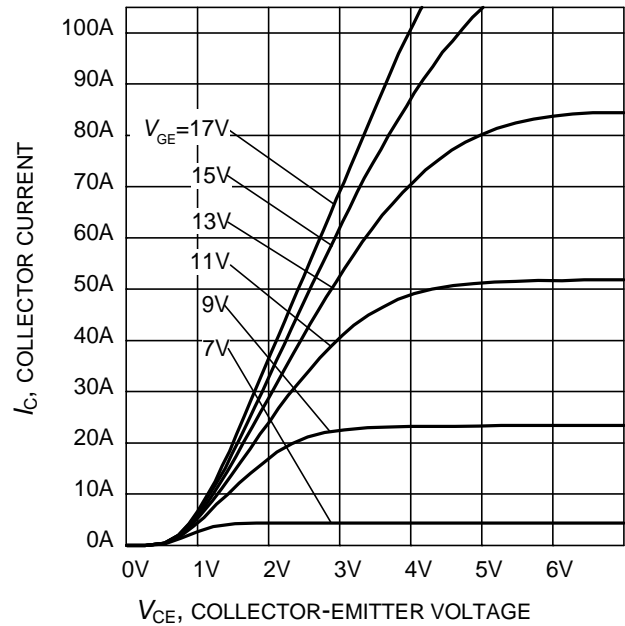
**Figure 3. Power dissipation as a function of case temperature**  
 ( $T_j \leq 150^\circ\text{C}$ )



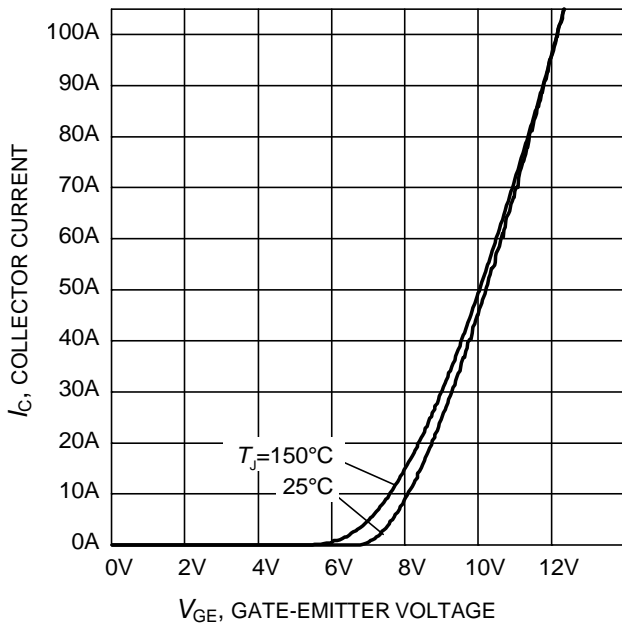
**Figure 4. Collector current as a function of case temperature**  
 ( $V_{GE} \geq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



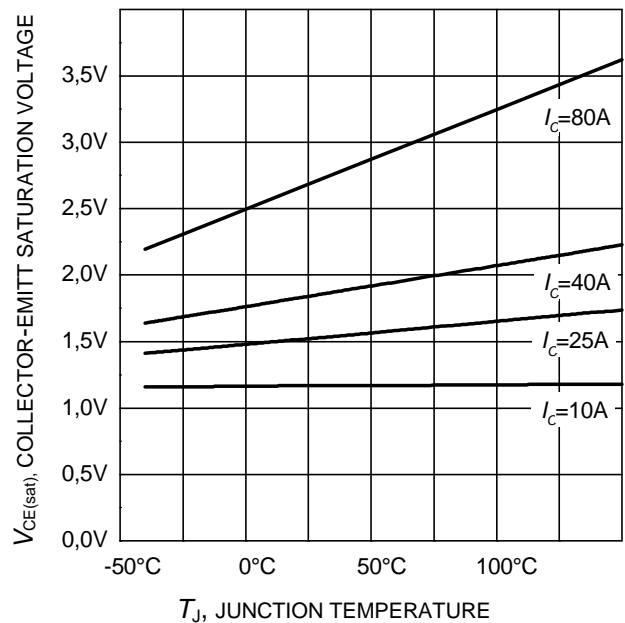
**Figure 5. Typical output characteristic**  
( $T_j = 25^\circ\text{C}$ )



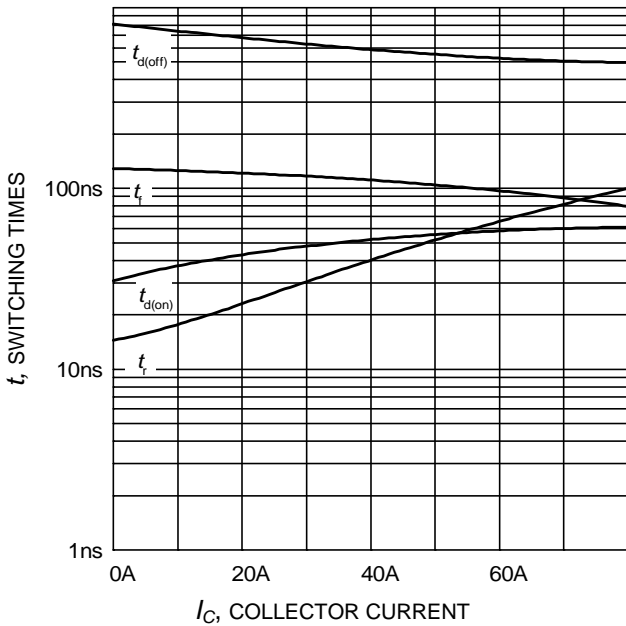
**Figure 6. Typical output characteristic**  
( $T_j = 150^\circ\text{C}$ )



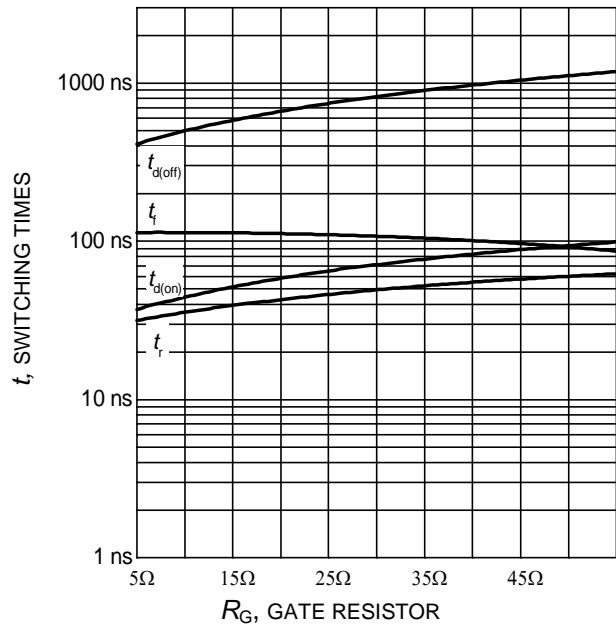
**Figure 7. Typical transfer characteristic**  
( $V_{CE} = 20\text{V}$ )



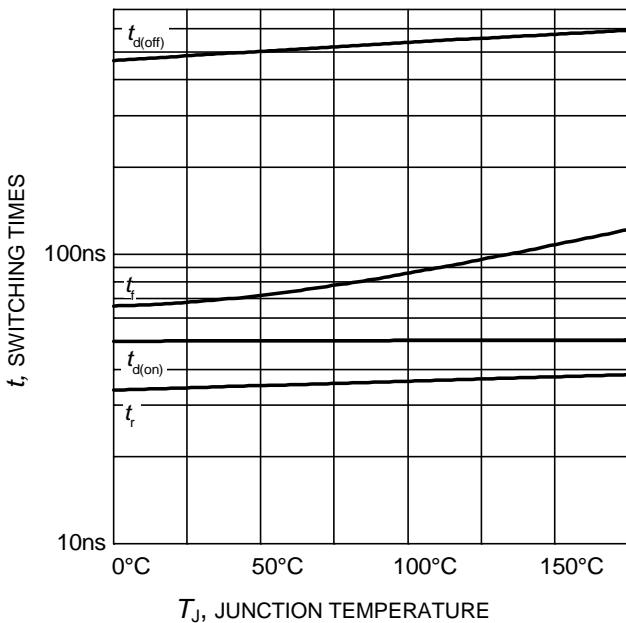
**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



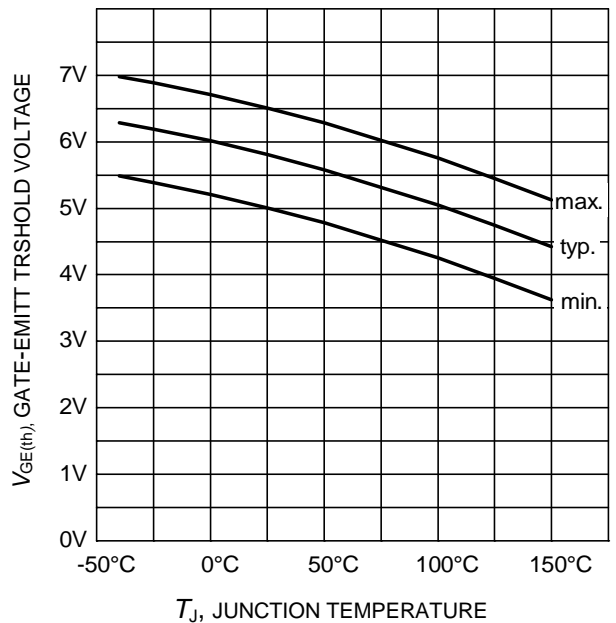
**Figure 9. Typical switching times as a function of collector current**  
(inductive load,  $T_J=150^{\circ}\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



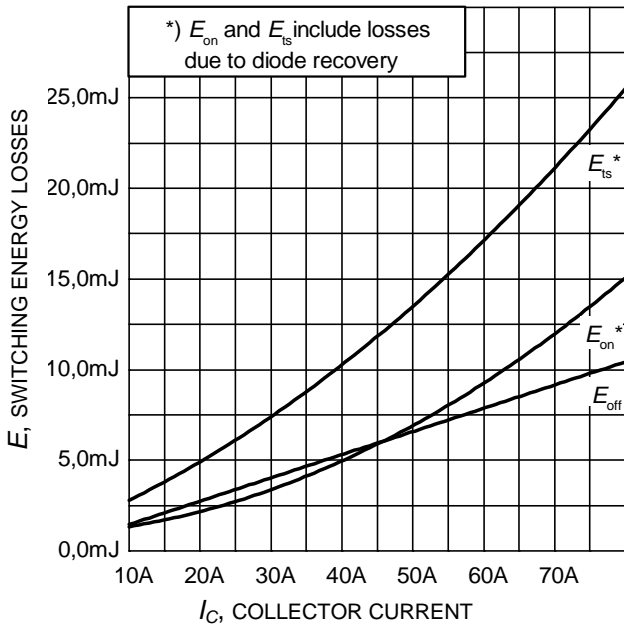
**Figure 10. Typical switching times as a function of gate resistor**  
(inductive load,  $T_J=150^{\circ}\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=40\text{A}$ , Dynamic test circuit in Figure E)



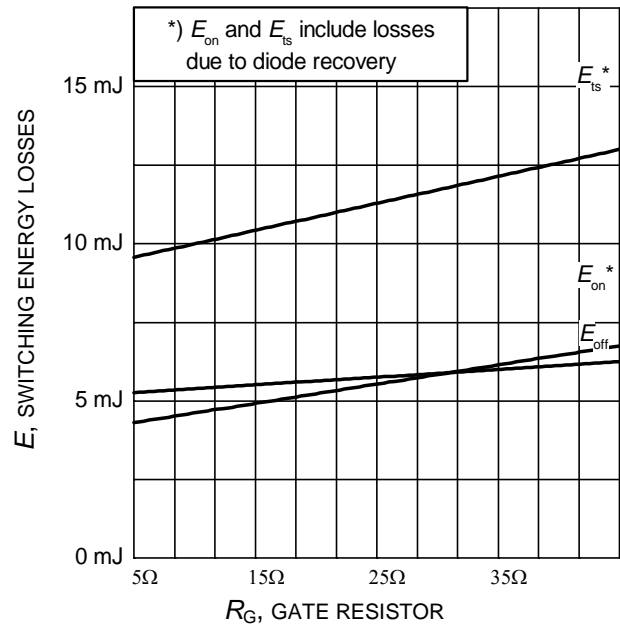
**Figure 11. Typical switching times as a function of junction temperature**  
(inductive load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=40\text{A}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



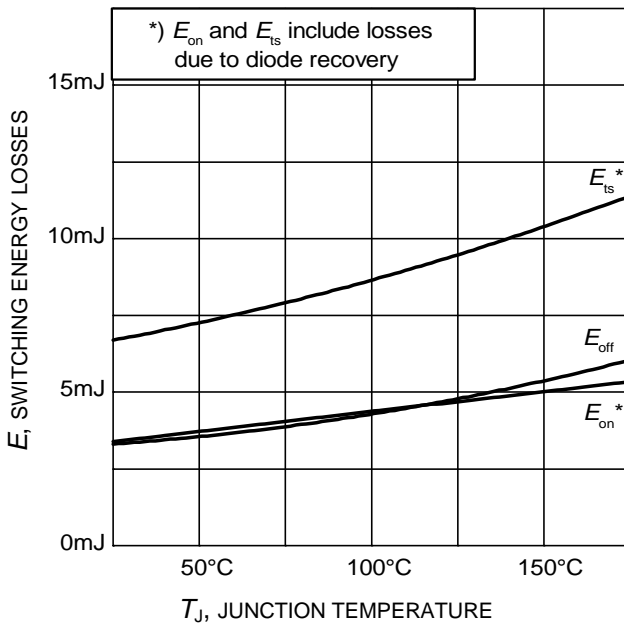
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**  
( $I_C = 1.5\text{mA}$ )



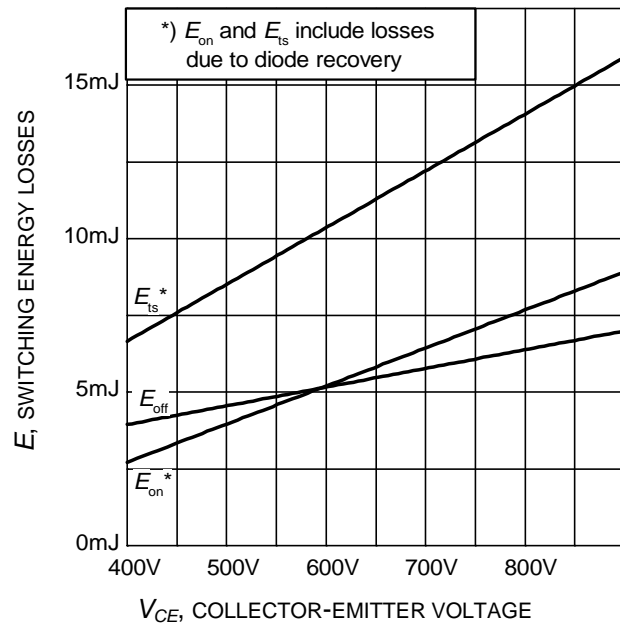
**Figure 13. Typical switching energy losses as a function of collector current**  
 (inductive load,  $T_J=150^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



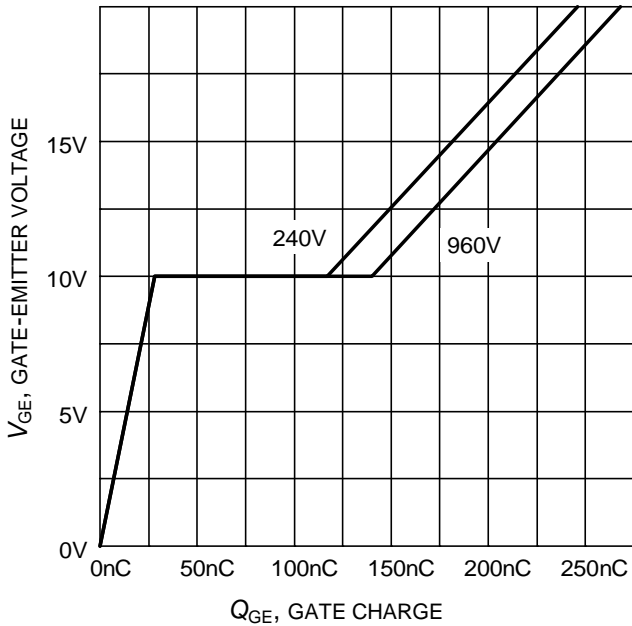
**Figure 14. Typical switching energy losses as a function of gate resistor**  
 (inductive load,  $T_J=150^\circ\text{C}$ ,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=40\text{A}$ , Dynamic test circuit in Figure E)



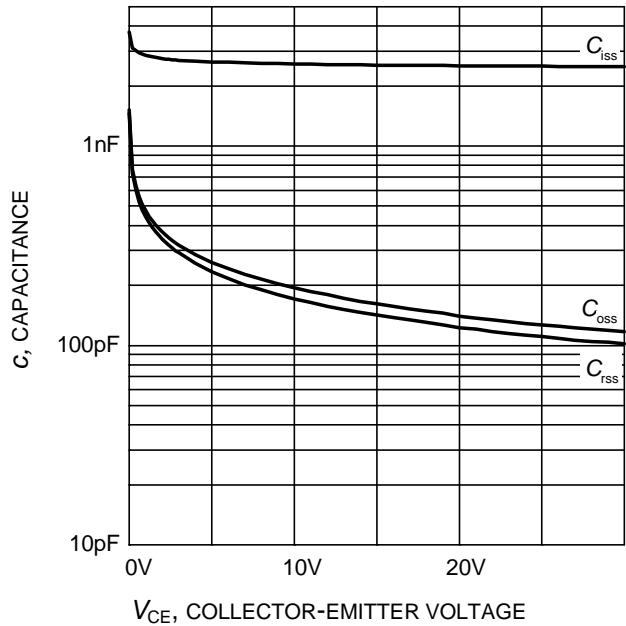
**Figure 15. Typical switching energy losses as a function of junction temperature**  
 (inductive load,  $V_{CE}=600\text{V}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=40\text{A}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



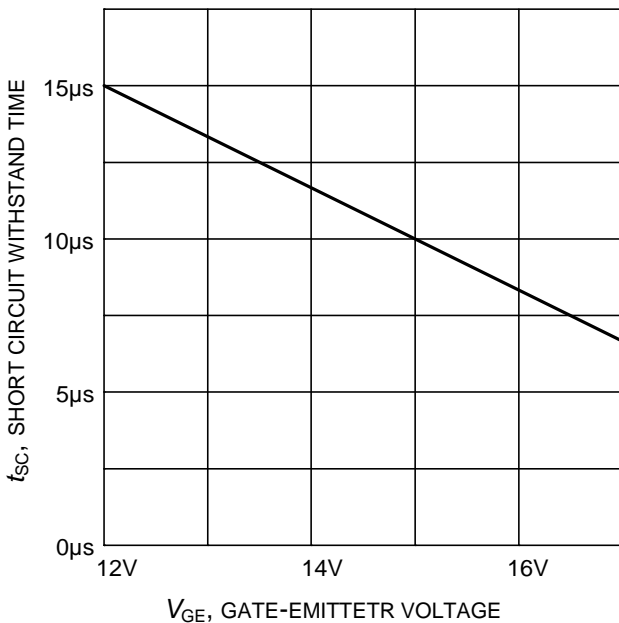
**Figure 16. Typical switching energy losses as a function of collector emitter voltage**  
 (inductive load,  $T_J=150^\circ\text{C}$ ,  $V_{GE}=0/15\text{V}$ ,  $I_C=40\text{A}$ ,  $R_G=15\Omega$ , Dynamic test circuit in Figure E)



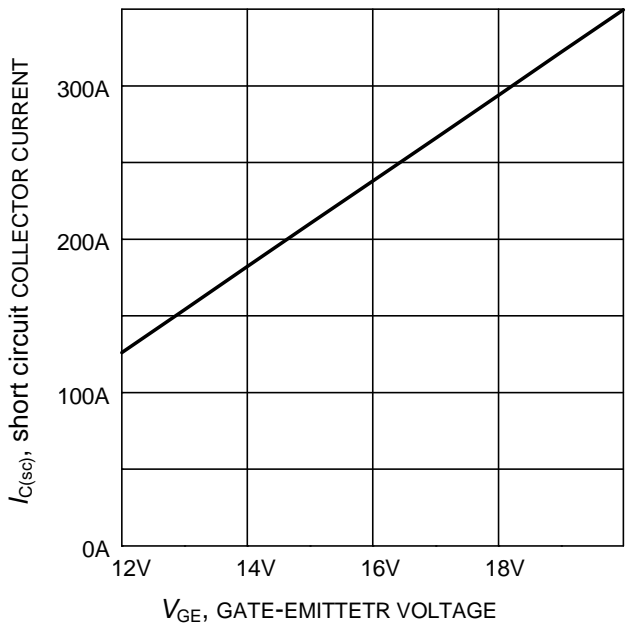
**Figure 17. Typical gate charge**  
( $I_C=40\text{ A}$ )



**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
( $V_{GE}=0\text{V}$ ,  $f = 1\text{ MHz}$ )

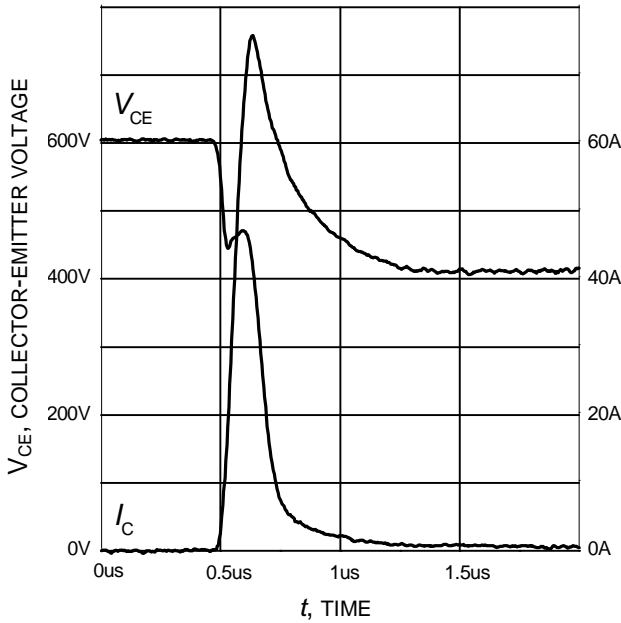


**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
( $V_{CE}=600\text{V}$ , start at  $T_j=25^\circ\text{C}$ )

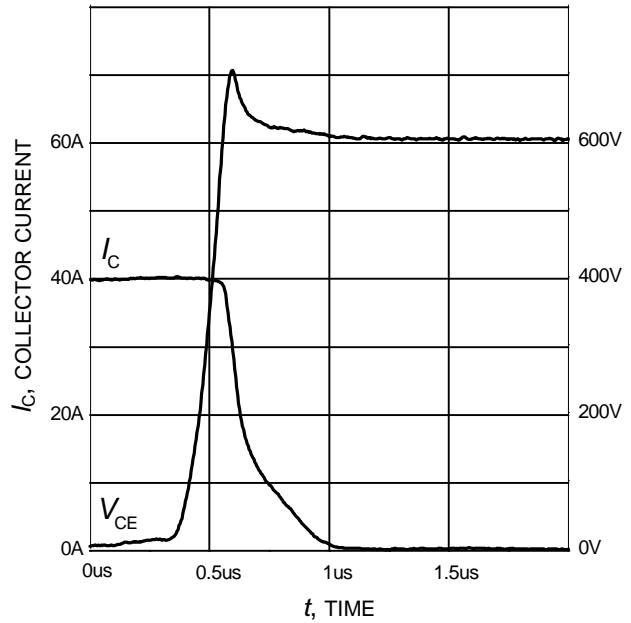


**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
( $V_{CE} \leq 600\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )

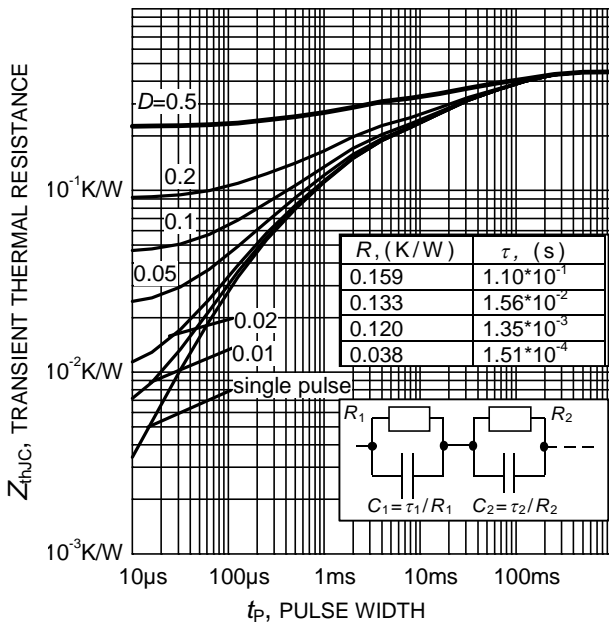




**Figure 21. Typical turn on behavior**  
 ( $V_{GE}=0/15V$ ,  $R_G=15\Omega$ ,  $T_j = 150^\circ C$ ,  
 Dynamic test circuit in Figure E)



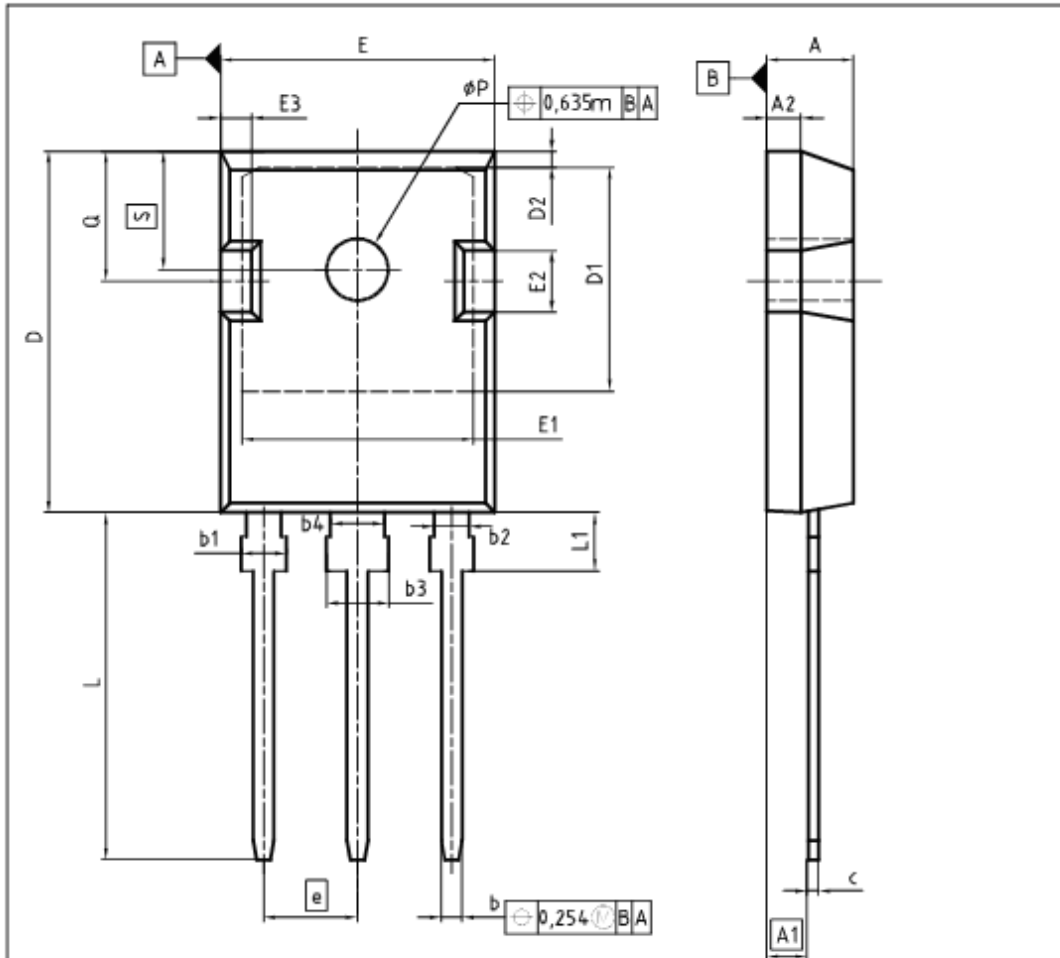
**Figure 22. Typical turn off behavior**  
 ( $V_{GE}=15/0V$ ,  $R_G=15\Omega$ ,  $T_j = 150^\circ C$ ,  
 Dynamic test circuit in Figure E)



**Figure 23. IGBT transient thermal resistance**  
 ( $D = t_p / T$ )

PG-TO247-3

TO247-3



| DIM   | MILLIMETERS |       | INCHES |       |
|-------|-------------|-------|--------|-------|
|       | MIN         | MAX   | MIN    | MAX   |
| A     | 4.83        | 5.21  | 0.190  | 0.205 |
| A1    | 2.27        | 2.54  | 0.089  | 0.100 |
| A2    | 1.85        | 2.16  | 0.073  | 0.085 |
| b     | 1.07        | 1.33  | 0.042  | 0.052 |
| b1    | 1.90        | 2.41  | 0.075  | 0.095 |
| b2    | 1.90        | 2.16  | 0.075  | 0.085 |
| b3    | 2.87        | 3.38  | 0.113  | 0.133 |
| b4    | 2.87        | 3.13  | 0.113  | 0.123 |
| c     | 0.55        | 0.68  | 0.022  | 0.027 |
| D     | 20.80       | 21.10 | 0.819  | 0.831 |
| D1    | 16.25       | 17.65 | 0.640  | 0.695 |
| D2    | 0.95        | 1.35  | 0.037  | 0.053 |
| E     | 15.70       | 16.13 | 0.618  | 0.635 |
| E1    | 13.10       | 14.15 | 0.516  | 0.557 |
| E2    | 3.68        | 5.10  | 0.145  | 0.201 |
| E3    | 1.00        | 2.60  | 0.039  | 0.102 |
| e     | 5.44        |       | 0.214  |       |
| N     | 3           |       | 3      |       |
| L     | 19.80       | 20.32 | 0.780  | 0.800 |
| L1    | 4.10        | 4.47  | 0.161  | 0.176 |
| phi P | 3.50        | 3.70  | 0.138  | 0.146 |
| Q     | 5.49        | 6.00  | 0.216  | 0.236 |
| S     | 6.04        | 6.30  | 0.238  | 0.248 |

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EUROPEAN PROJECTION

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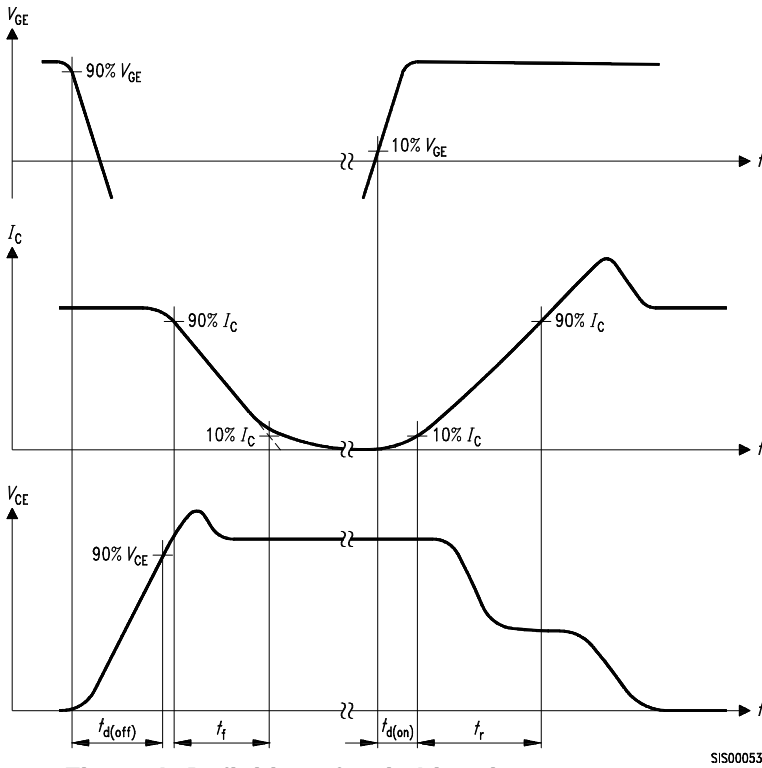


Figure A. Definition of switching times

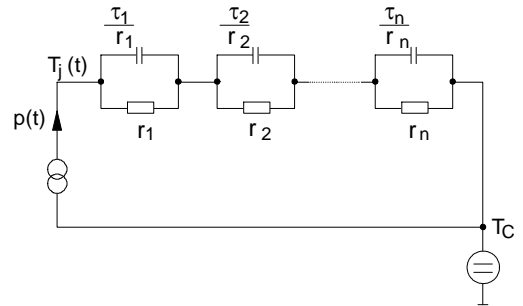


Figure D. Thermal equivalent circuit

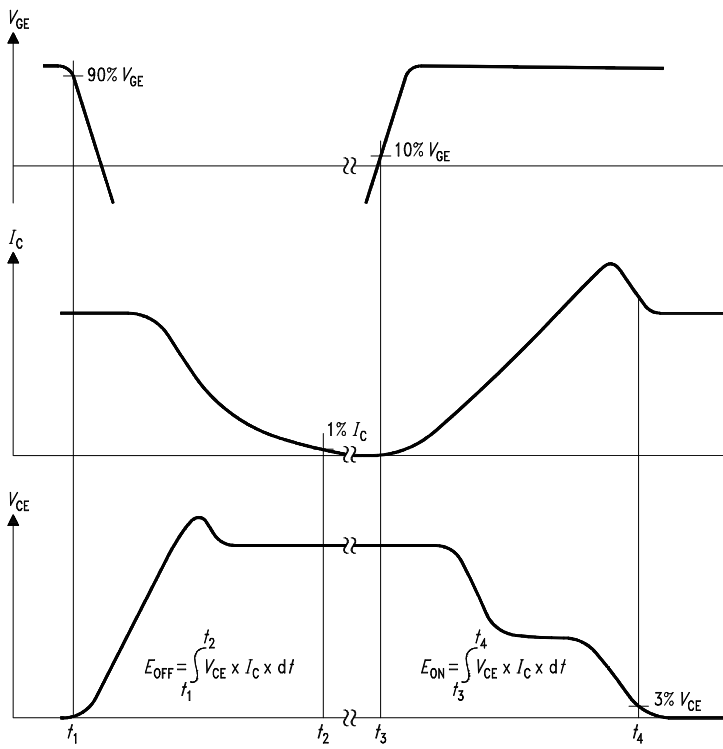


Figure B. Definition of switching losses

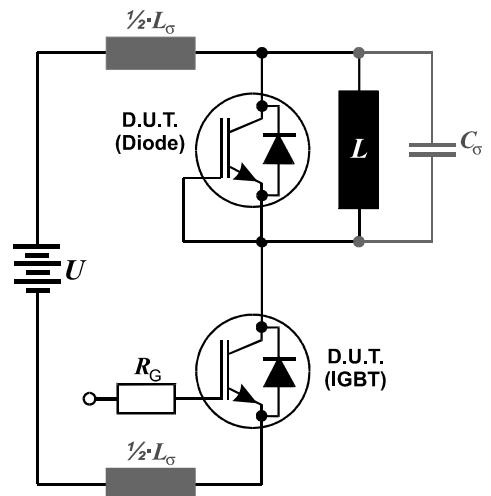


Figure E. Dynamic test circuit  
Leakage inductance  $L_{\sigma} = 180\text{nH}$   
and Stray capacity  $C_{\sigma} = 39\text{pF}$ .



TrenchStop<sup>®</sup> Series

IGW40T120

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